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January 2003



LM2940/LM2940C 1A Low Dropout Regulator General Description

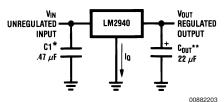
The LM2940/LM2940C positive voltage regulator features the ability to source 1A of output current with a dropout voltage of typically 0.5V and a maximum of 1V over the entire temperature range. Furthermore, a quiescent current reduction circuit has been included which reduces the ground current when the differential between the input voltage and the output voltage exceeds approximately 3V. The quiescent current with 1A of output current and an input-output differential of 5V is therefore only 30 mA. Higher quiescent currents only exist when the regulator is in the dropout mode (V_{IN} – V_{OUT} \leq 3V).

Designed also for vehicular applications, the LM2940/ LM2940C and all regulated circuitry are protected from reverse battery installations or 2-battery jumps. During line transients, such as load dump when the input voltage can momentarily exceed the specified maximum operating voltage, the regulator will automatically shut down to protect both the internal circuits and the load. The LM2940/ LM2940C cannot be harmed by temporary mirror-image insertion. Familiar regulator features such as short circuit and thermal overload protection are also provided.

Features

- Dropout voltage typically 0.5V @l_O = 1A
- Output current in excess of 1A
- Output voltage trimmed before assembly
- Reverse battery protection
- Internal short circuit current limit
- Mirror image insertion protection
- P⁺ Product Enhancement tested

Typical Application

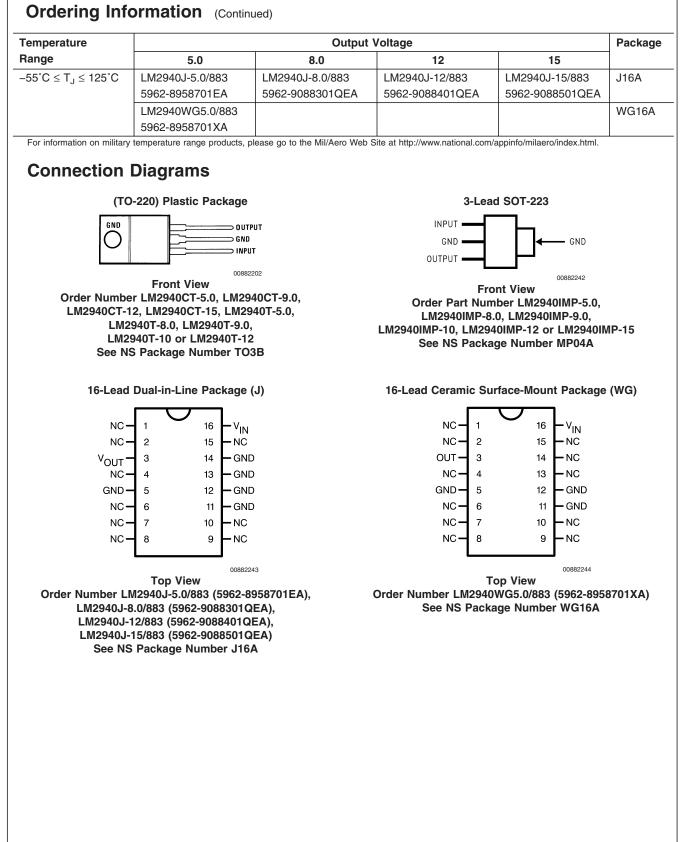


*Required if regulator is located far from power supply filter.

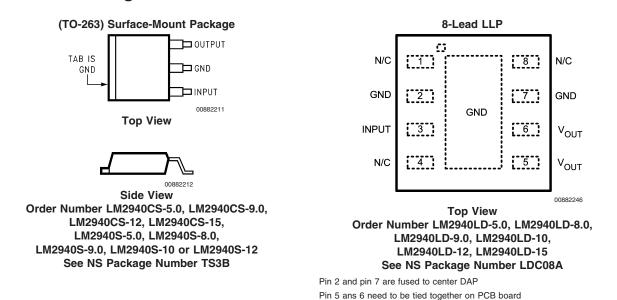
**C_{OUT} must be at least 22 µF to maintain stability. May be increased without bound to maintain regulation during transients. Locate as close as possible to the regulator. This capacitor must be rated over the same operating temperature range as the regulator and the ESR is critical; see curve.

Ordering Information

Temperature	Output Voltage							
Range	5.0	8.0	9.0	10	12	15	Package	
$0^{\circ}C \leq T_J \leq 125^{\circ}C$	LM2940CT-5.0		LM2940CT-9.0		LM2940CT-12	LM2940CT-15	TO-220	
	LM2940CS-5.0		LM2940CS-9.0		LM2940CS-12	LM2940CS-15	TO-263	
$-40^{\circ}C \le T_{J} \le 125^{\circ}C$	LM2940LD-5.0	LM2940LD-8.0	LM2940LD-9.0	LM2940LD-10	LM2940LD-12	LM2940LD-15	LLP 1k Units Tape and Reel	
	LM2940LDX-5.0	LM2940LDX-8.0	LM2940LDX-9.0	LM2940LDX-10	LM2940LDX-12	LM2940LDX-15	LLP 4.5k Units Tape and Reel	
$\begin{array}{l} -40^{\circ}C \leq T_{J} \leq \\ 125^{\circ}C \end{array}$	LM2940T-5.0	LM2940T-8.0	LM2940T-9.0	LM2940T-10	LM2940T-12		TO-220	
	LM2940S-5.0	LM2940S-8.0	LM2940S-9.0	LM2940S-10	LM2940S-12		TO-263	
$-40^{\circ}C \le T_{J} \le$	LM2940IMP-5.0	LM2940IMP-8.0	LM2940IMP-9.0	LM2940IMP-10	LM2940IMP-12	LM2940IMP-15	SOT-223	
85°C	LM2940IMPX-5.0	LM2940IMPX-8.0	LM2940IMPX-9.0	LM2940IMPX-10	LM2940IMPX-12	LM2940IMPX-15	SOT-223 in Tape and Reel	
SOT-223 Package Marking	L53B	L54B	LOEB	L55B	L56B	L70B		



Connection Diagrams (Continued)



Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/ Distributors for availability and specifications.

LM2940S, T, MP \leq 100 ms	60V
LM2940CS, T \leq 1 ms	45V
Internal Power Dissipation	
(Note 2)	Internally Limited
Maximum Junction Temperature	150°C
Storage Temperature Range	$-65^{\circ}C \leq T_{J} \leq +150^{\circ}C$
Lead Temperature, Time for Wave	Soldering
TO-220 (T) Package	260°C, 10s
TO-263 (S) Package	260°C, 4s

SOT-223 (MP) Package	260°C, 4s
ESD Susceptibility (Note 3)	2 kV

Operating Conditions (Note 1)

Input Voltage	26V
Temperature Range	
LM2940T, LM2940S	$-40^{\circ}C \leq T_{J} \leq 125^{\circ}C$
LM2940CT, LM2940CS	$0^{\circ}C \le T_{J} \le 125^{\circ}C$
LM2940IMP	$-40^{\circ}C \leq T_{J} \leq 85^{\circ}C$
LM2940J, LM2940WG	$-55^{\circ}C \le T_{J} \le 125^{\circ}C$
LM2940LD	$-40^{\circ}C \leq T_{J} \leq 125^{\circ}C$

Electrical Characteristics

 $V_{IN} = V_O + 5V$, $I_O = 1A$, $C_O = 22 \ \mu$ F, unless otherwise specified. Boldface limits apply over the entire operating temperature range of the indicated device. All other specifications apply for $T_A = T_J = 25$ °C.

Outpu	Output Voltage (V _o)		5V					
			LM2940	LM2940/883		LM2940	LM2940/883	11
Parameter	Conditions	Тур	Limit	Limit	Тур	Limit	Limit	Units
			(Note 4)	(Note 5)		(Note 4)	(Note 5)	
			$6.25V \leq V_{IN}$	≤ 26V		$9.4V \leq V_{IN}$	≤ 26V	
Output Voltage	$5 \text{ mA} \le I_O \le 1 \text{A}$	5.00	4.85/ 4.75	4.85/ 4.75	8.00	7.76/ 7.60	7.76/ 7.60	V _{MIN}
			5.15/ 5.25	5.15/ 5.25		8.24/ 8.40	8.24/ 8.40	V _{MAX}
Line Regulation	V_{O} + 2V \leq V_{IN} \leq 26V,	20	50	40/ 50	20	80	50/ 80	тV _{мА}
	$I_{O} = 5 \text{ mA}$							
Load Regulation	$50 \text{ mA} \le I_O \le 1\text{A}$							
	LM2940, LM2940/883	35	50/ 80	50/ 100	55	80/ 130	80/ 130	тV _{мА}
	LM2940C	35	50		55	80		
Output	100 mADC and							
Impedance	20 mArms,	35		1000/ 1000	55		1000/ 1000	mΩ
	f _O = 120 Hz							
Quiescent	V_{O} +2V \leq $V_{IN} \leq$ 26V,							
Current	I _O = 5 mA							
	LM2940, LM2940/883	10	15/ 20	15/ 20	10	15/ 20	15/ 20	mA _{MA}
	LM2940C	10	15					
	$V_{\rm IN} = V_{\rm O} + 5V,$	30	45/ 60	50/ 60	30	45/ 60	50/ 60	mА _{мА}
	I _O = 1A							
Output Noise	10 Hz – 100 kHz,	150		700/ 700	240		1000/ 1000	μV _{rm}
Voltage	I _O = 5 mA							
Ripple Rejection	f _o = 120 Hz, 1 V _{rms} ,							
	I _O = 100 mA							
	LM2940	72	60/ 54		66	54/ 48		dB _{MIR}
	LM2940C	72	60		66	54		
	$f_{O} = 1 \text{ kHz}, 1 \text{ V}_{rms},$			60/ 50			54/ 48	dB _{MII}
	I _O = 5 mA							
Long Term		20			32			mV/
Stability								1000
Dropout Voltage	I _O = 1A	0.5	0.8/ 1.0	0.7/ 1.0	0.5	0.8/ 1.0	0.7/ 1.0	V _{MA>}
	I _O = 100 mA	110	150/ 200	150/ 200	110	150/ 200	150/ 200	тV _{мА}
Short Circuit Current	(Note 6)	1.9	1.6	1.5/ 1.3	1.9	1.6	1.6/ 1.3	A _{MIN}

Electrical Characteristics (Continued)

 $V_{IN} = V_O + 5V$, $I_O = 1A$, $C_O = 22 \ \mu$ F, unless otherwise specified. Boldface limits apply over the entire operating temperature range of the indicated device. All other specifications apply for $T_A = T_J = 25^{\circ}$ C.

Output Voltage (V _O)			5V			8V			
			LM2940	LM2940/883		LM2940	LM2940/883	Units	
Parameter	Conditions	Тур	Limit	Limit	Тур	Limit	Limit	Units	
			(Note 4)	(Note 5)		(Note 4)	(Note 5)		
Maximum Line	R _O = 100Ω								
Transient	LM2940, T ≤ 100 ms	75	60/ 60		75	60/ 60		V	
	LM2940/883, T \leq 20 ms			40/ 40			40/ 40	V _{MIN}	
	LM2940C, T ≤ 1 ms	55	45		55	45			
Reverse Polarity	R _O = 100Ω								
DC Input Voltage	LM2940, LM2940/883	-30	-15/ -15	-15/ -15	-30	-15/ -15	-15/ -15	V _{MIN}	
	LM2940C	-30	-15		-30	-15			
Reverse Polarity	R _O = 100Ω								
Transient Input	LM2940, T ≤ 100 ms	-75	-50/ -50		-75	-50/ -50		V _{MIN}	
Voltage	LM2940/883, T ≤ 20 ms			-45/ -45			-45/ -45		
	LM2940C, T ≤ 1 ms	-55	-45/ -45						

Electrical Characteristics

 $V_{IN} = V_O + 5V$, $I_O = 1A$, $C_O = 22 \ \mu$ F, unless otherwise specified. Boldface limits apply over the entire operating temperature range of the indicated device. All other specifications apply for $T_A = T_J = 25^{\circ}$ C.

Output Voltage (V _o)			9V			
			LM2940		LM2940	1
Parameter	Conditions	Тур	Limit	Тур	Limit	Units
			(Note 4)		(Note 4)	
		10.5V	$\leq V_{IN} \leq 26V$	11.5V	′ ≤ V _{IN} ≤ 26V	
Output Voltage	5 mA ≤ I _O ≤1A	9.00	8.73/ 8.55	10.00	9.70/ 9.50	V _{MIN}
			9.27/ 9.45		10.30/ 10.50	V _{MAX}
Line Regulation	$V_{O} + 2V \le V_{IN} \le 26V,$	20	90	20	100	mV _{MAX}
	$I_{O} = 5 \text{ mA}$					
Load Regulation	$50 \text{ mA} \le I_O \le 1\text{A}$					
	LM2940	60	90/ 150	65	100/ 165	mV _{MAX}
	LM2940C	60	90			
Output Impedance	100 mADC and					
	20 mArms,	60		65		mΩ
	f _o = 120 Hz					
Quiescent	$V_{\rm O} + 2V \le V_{\rm IN} < 26V,$					
Current	$I_{O} = 5 \text{ mA}$					
	LM2940	10	15/ 20	10	15/ 20	mA _{MAX}
	LM2940C	10	15			
	$V_{IN} = V_{O} + 5V, I_{O} = 1A$	30	45/ 60	30	45/ 60	mA _{MAX}
Output Noise	10 Hz – 100 kHz,	270		300		μV _{rms}
Voltage	$I_{O} = 5 \text{ mA}$					
Ripple Rejection	f _o = 120 Hz, 1 V _{rms} ,					
	I _O = 100 mA					
	LM2940	64	52/ 46	63	51/ 45	dB _{MIN}
	LM2940C	64	52			
Long Term		34		36		mV/
Stability						1000 Hr
Dropout Voltage	I _O = 1A	0.5	0.8/ 1.0	0.5	0.8/ 1.0	V _{MAX}
	$I_{O} = 100 \text{ mA}$	110	150/ 200	110	150/ 200	mV _{MAX}

Electrical Characteristics (Continued)

 $V_{IN} = V_O + 5V$, $I_O = 1A$, $C_O = 22 \ \mu$ F, unless otherwise specified. Boldface limits apply over the entire operating temperature range of the indicated device. All other specifications apply for $T_A = T_J = 25^{\circ}$ C.

Out	out Voltage (V _o)		9V		10V		
Parameter	Conditions	Тур	LM2940 Limit (Note 4)	Тур	LM2940 Limit (Note 4)	Units	
Short Circuit Current	(Note 6)	1.9	1.6	1.9	1.6	A _{MIN}	
Maximum Line Transient	$\begin{array}{l} R_{O} = 100\Omega \\ T \leq 100 \text{ ms} \end{array}$						
	LM2940 LM2940C	75 55	60/ 60 45	75	60/ 60	V _{MIN}	
Reverse Polarity DC Input Voltage	R _O = 100Ω LM2940 LM2940C	-30 -30	-15/ -15 -15	-30	-15/ -15	V _{MIN}	
Reverse Polarity Transient Input Voltage	$R_{o} = 100\Omega$ T ≤ 100 ms LM2940 LM2940C	-75 -55	-50/ -50 -45/ -45	-75	-50/ -50	V _{MIN}	

Electrical Characteristics

 $V_{IN} = V_O + 5V$, $I_O = 1A$, $C_O = 22 \ \mu$ F, unless otherwise specified. Boldface limits apply over the entire operating temperature range of the indicated device. All other specifications apply for $T_A = T_J = 25$ °C.

Output Voltage (V _O)		12V						
			LM2940	LM2940/833		LM2940	LM2940/833	
Parameter	Conditions	Тур	Limit	Limit	Тур	Limit	Limit	Units
			(Note 4)	(Note 5)		(Note 4)	(Note 5)	
			$13.6V \le V_{IN}$	≤ 26V		$16.75V \leq V_{IN}$	≤ 26V	
Output Voltage	$5 \text{ mA} \le I_O \le 1 \text{A}$	12.00	11.64/ 11.40	11.64/ 11.40	15.00	14.55/ 14.25	14.55/ 14.25	V _{MIN}
			12.36/ 12.60	12.36/ 12.60		15.45/ 15.75	15.45/ 15.75	V _{MAX}
Line Regulation	$V_{O} + 2V \le V_{IN} \le 26V,$	20	120	75/ 120	20	150	95/ 150	mV _{MAX}
	$I_{O} = 5 \text{ mA}$							
Load Regulation	$50 \text{ mA} \le I_O \le 1\text{A}$							
	LM2940, LM2940/883	55	120/ 200	120/ 190			150/ 240	mV _{MAX}
	LM2940C	55	120		70	150		
Output	100 mADC and							
Impedance	20 mArms,	80		1000/ 1000	100		1000/ 1000	mΩ
	f _o = 120 Hz							
Quiescent	V_{O} +2V \leq $V_{IN} \leq$ 26V,							
Current	$I_0 = 5 \text{ mA}$							
	LM2940, LM2940/883	10	15/ 20	15/ 20			15/ 20	mA _{MAX}
	LM2940C	10	15		10	15		
	$V_{IN} = V_O + 5V, I_O = 1A$	30	45/ 60	50/ 60	30	45/ 60	50/ 60	mA _{MAX}
Output Noise	10 Hz – 100 kHz,	360		1000/ 1000	450		1000/ 1000	μV _{rms}
Voltage	l _o = 5 mA							
Ripple Rejection	$f_{O} = 120 \text{ Hz}, 1 \text{ V}_{\text{rms}},$							
	I _O = 100 mA							
	LM2940	66	54/ 48					dB _{MIN}
	LM2940C	66	54		64	52		
	$f_{O} = 1 \text{ kHz}, 1 \text{ V}_{\text{rms}},$			52/ 46			48/ 42	dB _{MIN}
	$I_{O} = 5 \text{ mA}$			52/40			40/42	

Electrical Characteristics (Continued)

 $V_{IN} = V_O + 5V$, $I_O = 1A$, $C_O = 22 \ \mu$ F, unless otherwise specified. Boldface limits apply over the entire operating temperature range of the indicated device. All other specifications apply for $T_A = T_J = 25^{\circ}$ C.

Outpu	Output Voltage (V _o)		12V			15V			
			LM2940	LM2940/833		LM2940	LM2940/833	Unite	
Parameter	Conditions	Тур	Limit	Limit	Тур	Limit	Limit	Units	
			(Note 4)	(Note 5)		(Note 4)	(Note 5)		
Long Term		40			<u> </u>			mV/	
Stability		48			60			1000 Hr	
Dropout Voltage	I _O = 1A	0.5	0.8/ 1.0	0.7/ 1.0	0.5	0.8/ 1.0	0.7/ 1.0	V _{MAX}	
	I _O = 100 mA	110	150/ 200	150/ 200	110	150/ 200	150/ 200	mV _{MAX}	
Short Circuit	(Note 6)	1.9	1.6	1.6/ 1.3	1.9	1.6	1.6/ 1.3	^	
Current		1.9	1.0	1.0/1.3	1.9	1.0	1.0/1.3	A _{MIN}	
Maximum Line	R _O = 100Ω								
Transient	LM2940, T ≤ 100 ms	75	60/ 60						
	LM2940/883, T ≤ 20 ms			40/ 40			40/ 40	V _{MIN}	
	LM2940C, T \leq 1 ms	55	45		55	45			
Reverse Polarity	R _O = 100Ω								
DC Input	LM2940, LM2940/883	-30	-15/ -15	-15/ -15			-15/ -15	V _{MIN}	
Voltage	LM2940C	-30	-15		-30	-15			
Reverse Polarity	R _O = 100Ω								
Transient Input	LM2940, T ≤ 100 ms	-75	-50/ -50						
Voltage	LM2940/883, T ≤ 20 ms			-45/ -45			-45/ -45	V _{MIN}	
	LM2940C, T ≤ 1 ms	-55	-45/ -45		-55	-45/ -45			

Thermal Performance

Thermal Resistance	3-Lead TO-220	4	°C/W
Junction-to-Case	3-Lead TO-263	4	°C/W
Thermal Resistance	3-Lead TO-220	60	°C/W
Junction-to-Ambient	3-Lead TO-263	80	°C/W
	8-Lead LLP (Note 2)	35	°C/W

Note 1: Absolute Maximum Ratings are limits beyond which damage to the device may occur. Operating Conditions are conditions under which the device functions but the specifications might not be guaranteed. For guaranteed specifications and test conditions see the Electrical Characteristics.

Note 2: The maximum allowable power dissipation is a function of the maximum junction temperature, T_J , the junction-to-ambient thermal resistance, θ_{JA} , and the ambient temperature, T_A . Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. The value of θ_{JA} (for devices in still air with no heatsink) is 60°C/W for the TO-220 package, 80°C/W for the TO-263 package, and 174°C/W for the SOT-223 package. The effective value of θ_{JA} can be reduced by using a heatsink (see Application Hints for specific information on heatsinking). The value of θ_{JA} for the LLP package is specifically dependent on PCB trace area, trace material, and the number of layers and thermal vias. For improved thermal resistance and power dissipation for the LLP package, refer to Application Note AN-1187. It is recommended that 6 vias be placed under the center pad to improve thermal performance.

Note 3: ESD rating is based on the human body model, 100 pF discharged through 1.5 k $\Omega.$

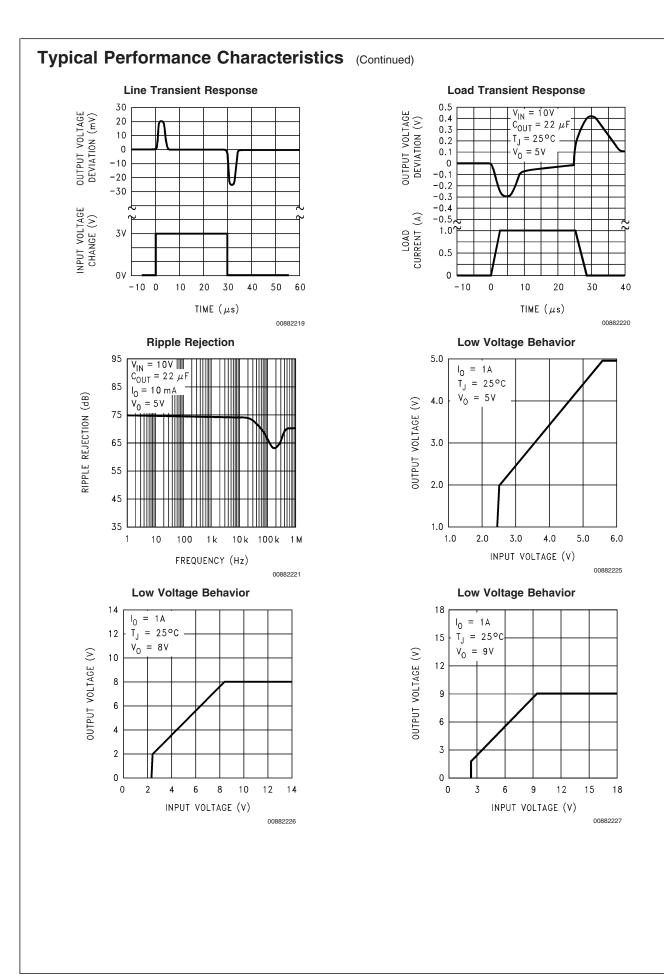
Note 4: All limits are guaranteed at $T_A = T_J = 25^{\circ}C$ only (standard typeface) or over the entire operating temperature range of the indicated device (boldface type). All limits at $T_A = T_J = 25^{\circ}C$ are 100% production tested. All limits at temperature extremes are guaranteed via correlation using standard Statistical Quality Control methods.

Note 5: All limits are guaranteed at $T_A = T_J = 25^{\circ}C$ only (standard typeface) or over the entire operating temperature range of the indicated device (boldface type). All limits are 100% production tested and are used to calculate Outgoing Quality Levels.

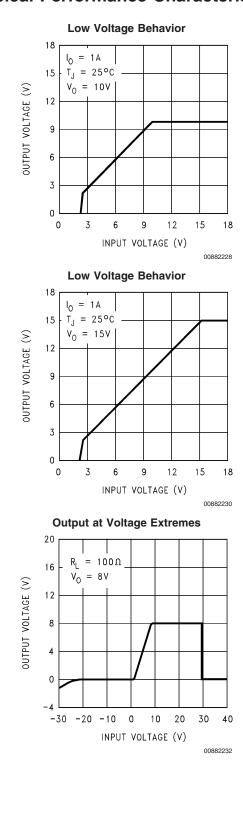
Note 6: Output current will decrease with increasing temperature but will not drop below 1A at the maximum specified temperature.

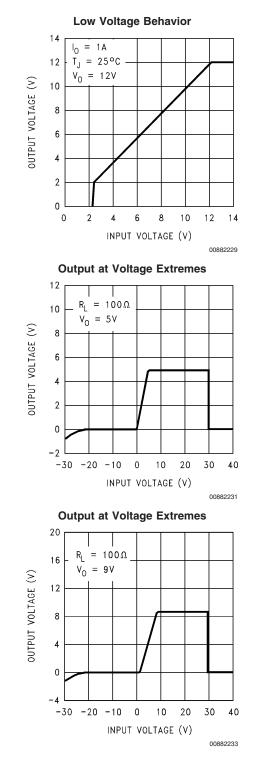


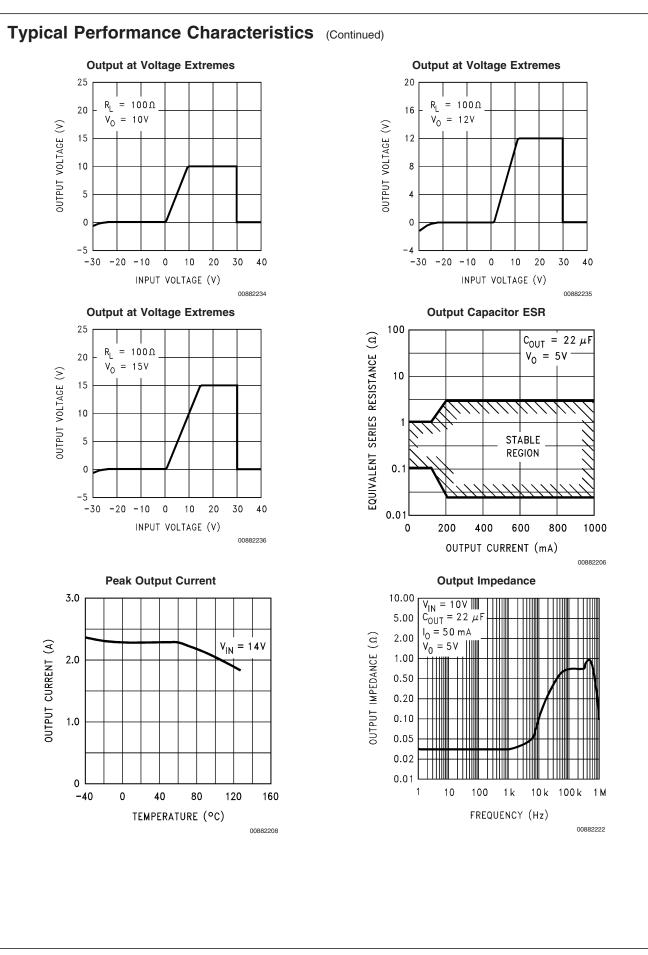
Typical Performance Characteristics Dropout Voltage Dropout Voltage vs. Temperature 0.9 1.0 $T_J = 25^{\circ}C$ INPUT-OUTPUT DIFFERENTIAL (V) 0.9 0.8 0.8 0.7 DROPOUT VOLTAGE (V) 0.7 0.6 0.6 0.5 0.5 0.4 0.4 500 mA 0.3 0.3 0.2 0.2 100 mA 0.1 0.1 0 0 0 200 400 600 800 1000 0 40 80 120 160 -40 OUTPUT CURRENT (mA) TEMPERATURE (°C) 00882214 00882213 **Output Voltage vs. Temperature Quiescent Current vs. Temperature** 5.10 50 $V_{IN} = V_0 + 5V$ 5.08 QUIESCENT CURRENT (mA) 5.06 40 OUTPUT VOLTAGE (5V) 5.04 5.02 30 5.00 4.98 20 500 mA 4.96 10 m A 4.94 10 4.92 4.90 0 0 0 -40 40 80 120 160 -40 40 80 120 160 TEMPERATURE (°C) TEMPERATURE (°C) 00882215 00882216 **Quiescent Current Quiescent Current** 200 50 180 QUIESCENT CURRENT (mA) QUIESCENT CURRENT (mA) 160 40 140 $V_{IN} = 14V$ 120 30 $V_0 = 5V$ 100 = 25°C T₁ 80 20 100 mA 60 500 mA 40 10 20 0 0 5 15 20 25 0.6 0 10 30 35 0 0.2 0.4 0.8 1.0 INPUT VOLTAGE (V) LOAD CURRENT (A) 00882217 00882218



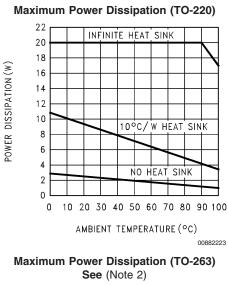
Typical Performance Characteristics (Continued)

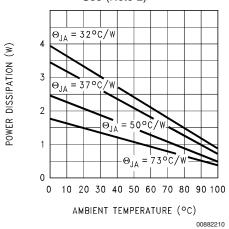


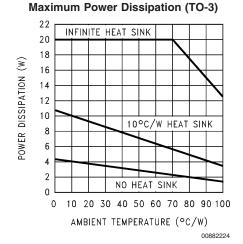


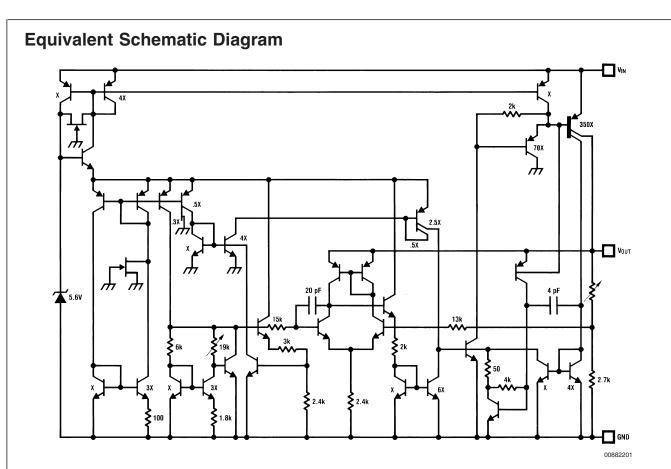


Typical Performance Characteristics (Continued)









Application Hints

EXTERNAL CAPACITORS

The output capacitor is critical to maintaining regulator stability, and must meet the required conditions for both ESR (Equivalent Series Resistance) and minimum amount of capacitance.

MINIMUM CAPACITANCE:

The minimum output capacitance required to maintain stability is 22 μF (this value may be increased without limit). Larger values of output capacitance will give improved transient response.

ESR LIMITS:

The ESR of the output capacitor will cause loop instability if it is too high or too low. The acceptable range of ESR plotted versus load current is shown in the graph below. *It is essential that the output capacitor meet these requirements, or oscillations can result.* Output Capacitor ESR

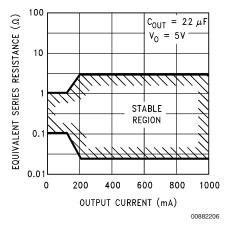


FIGURE 1. ESR Limits

It is important to note that for most capacitors, ESR is specified only at room temperature. However, the designer must ensure that the ESR will stay inside the limits shown over the entire operating temperature range for the design.

For aluminum electrolytic capacitors, ESR will increase by about 30X as the temperature is reduced from 25° C to -40° C. This type of capacitor is not well-suited for low temperature operation.

Solid tantalum capacitors have a more stable ESR over temperature, but are more expensive than aluminum electrolytics. A cost-effective approach sometimes used is to

Application Hints (Continued)

parallel an aluminum electrolytic with a solid Tantalum, with the total capacitance split about 75/25% with the Aluminum being the larger value.

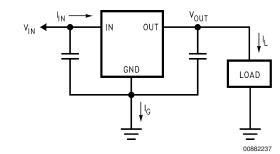
If two capacitors are paralleled, the effective ESR is the parallel of the two individual values. The "flatter" ESR of the Tantalum will keep the effective ESR from rising as quickly at low temperatures.

HEATSINKING

A heatsink may be required depending on the maximum power dissipation and maximum ambient temperature of the application. Under all possible operating conditions, the junction temperature must be within the range specified under Absolute Maximum Ratings.

To determine if a heatsink is required, the power dissipated by the regulator, P_D , must be calculated.

The figure below shows the voltages and currents which are present in the circuit, as well as the formula for calculating the power dissipated in the regulator:



$$\begin{split} I_{IN} &= I_L \div I_G \\ P_D &= (V_{IN} - V_{OUT}) \ I_L + (V_{IN}) \ I_G \end{split}$$

FIGURE 2. Power Dissipation Diagram

The next parameter which must be calculated is the maximum allowable temperature rise, $T_{\rm R}$ (max). This is calculated by using the formula:

 T_{R} (max) = T_{J} (max) - T_{A} (max)

- where: T_J (max) is the maximum allowable junction temperature, which is 125°C for commercial grade parts.
 - T_A (max) is the maximum ambient temperature which will be encountered in the application.

Using the calculated values for $T_{R}(max)$ and P_{D} , the maximum allowable value for the junction-to-ambient thermal resistance, $\theta_{(JA)}$, can now be found:

$$\theta_{(JA)} = T_R (max)/P_D$$

IMPORTANT: If the maximum allowable value for $\theta_{(JA)}$ is found to be $\geq 53^{\circ}$ C/W for the TO-220 package, $\geq 80^{\circ}$ C/W for the TO-263 package, or $\geq 174^{\circ}$ C/W for the SOT-223 package, no heatsink is needed since the package alone will dissipate enough heat to satisfy these requirements.

If the calculated value for $\theta_{(\mathsf{JA})} \text{falls}$ below these limits, a heatsink is required.

HEATSINKING TO-220 PACKAGE PARTS

The TO-220 can be attached to a typical heatsink, or secured to a copper plane on a PC board. If a copper plane is to be used, the values of $\theta_{(JA)}$ will be the same as shown in the next section for the TO-263.

If a manufactured heatsink is to be selected, the value of heatsink-to-ambient thermal resistance, $\theta_{(\text{H}-\text{A})},$ must first be calculated:

$$\theta_{(H-A)} = \theta_{(JA)} - \theta_{(C-H)} - \theta_{(J-C)}$$

- Where: $\theta_{(J-C)}$ is defined as the thermal resistance from the junction to the surface of the case. A value of 3°C/W can be assumed for $\theta_{(J-C)}$ for this calculation.
 - $\begin{array}{l} \theta_{(\text{C}-\text{H})} & \text{is defined as the thermal resistance between} \\ & \text{the case and the surface of the heatsink. The} \\ & \text{value of } \theta_{(\text{C}-\text{H})} \text{ will vary from about } 1.5^{\circ}\text{C/W to} \\ & \text{about } 2.5^{\circ}\text{C/W} \text{ (depending on method of attachment, insulator, etc.). If the exact value is} \\ & \text{unknown, } 2^{\circ}\text{C/W} \text{ should be assumed for} \\ & \theta_{(\text{C}-\text{H})}. \end{array}$

When a value for $\theta_{(H-A)}$ is found using the equation shown, a heatsink must be selected that has a value that is less than or equal to this number.

 $\theta_{(\text{H}-\text{A})}$ is specified numerically by the heatsink manufacturer in the catalog, or shown in a curve that plots temperature rise vs power dissipation for the heatsink.

HEATSINKING TO-263 AND SOT-223 PACKAGE PARTS

Both the TO-263 ("S") and SOT-223 ("MP") packages use a copper plane on the PCB and the PCB itself as a heatsink. To optimize the heat sinking ability of the plane and PCB, solder the tab of the package to the plane.

Figure 3 shows for the TO-263 the measured values of $\theta_{(JA)}$ for different copper area sizes using a typical PCB with 1 ounce copper and no solder mask over the copper area used for heatsinking.

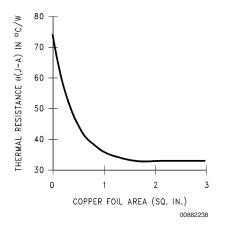
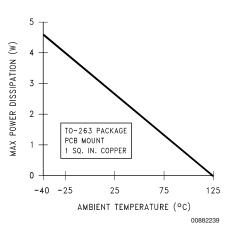


FIGURE 3. $\theta_{(JA)}$ vs. Copper (1 ounce) Area for the TO-263 Package

As shown in the figure, increasing the copper area beyond 1 square inch produces very little improvement. It should also be observed that the minimum value of $\theta_{(JA)}$ for the TO-263 package mounted to a PCB is 32°C/W.

As a design aid, *Figure 4* shows the maximum allowable power dissipation compared to ambient temperature for the TO-263 device (assuming $\theta_{(JA)}$ is 35°C/W and the maximum junction temperature is 125°C).

Application Hints (Continued)



AMBIENT TEMPERATURE (°C) 00882239 FIGURE 4. Maximum Power Dissipation vs. T_{AMB} for

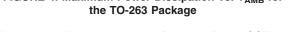


Figure 5 and *Figure 6* show the information for the SOT-223 package. *Figure 6* assumes a $\theta_{(JA)}$ of 74°C/W for 1 ounce copper and 51°C/W for 2 ounce copper and a maximum junction temperature of 125°C.

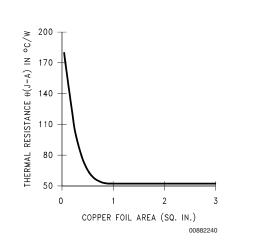


FIGURE 5. $\theta_{(JA)}$ vs. Copper (2 ounce) Area for the SOT-223 Package

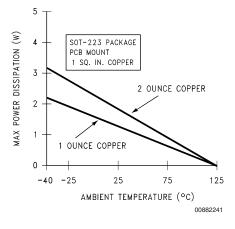
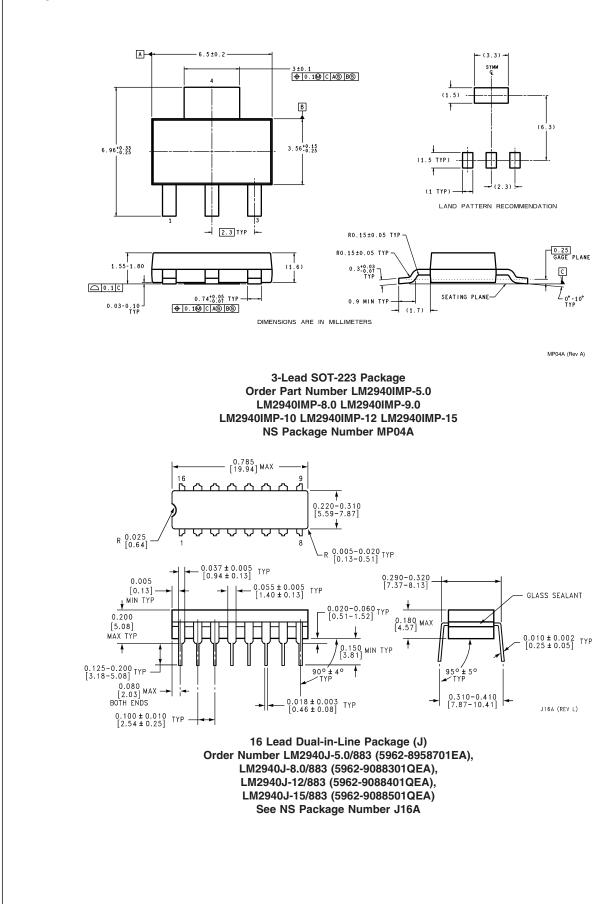
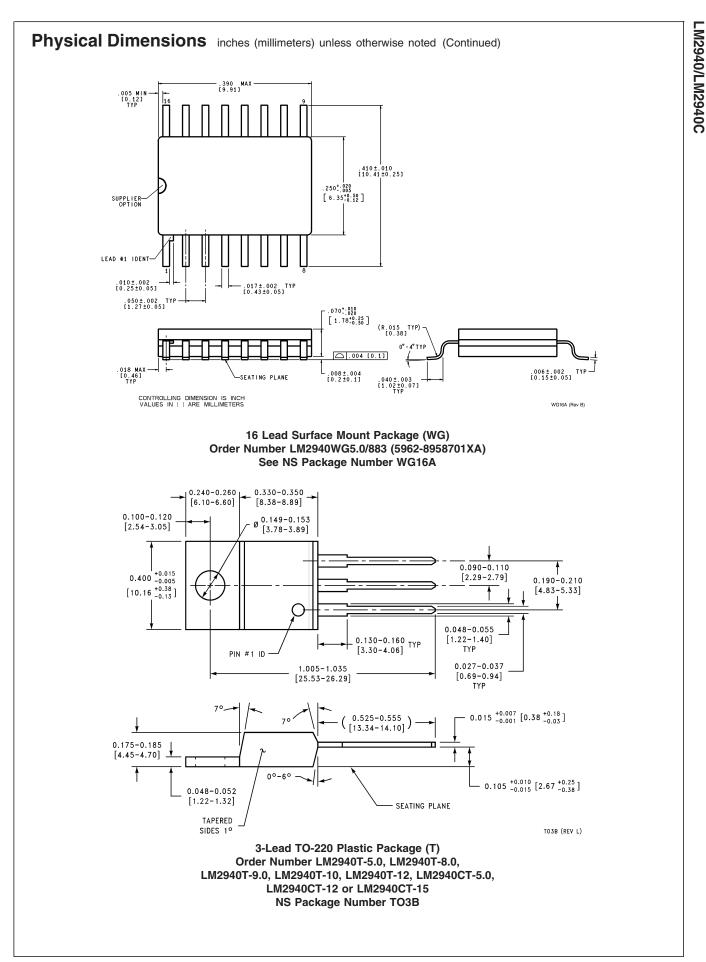
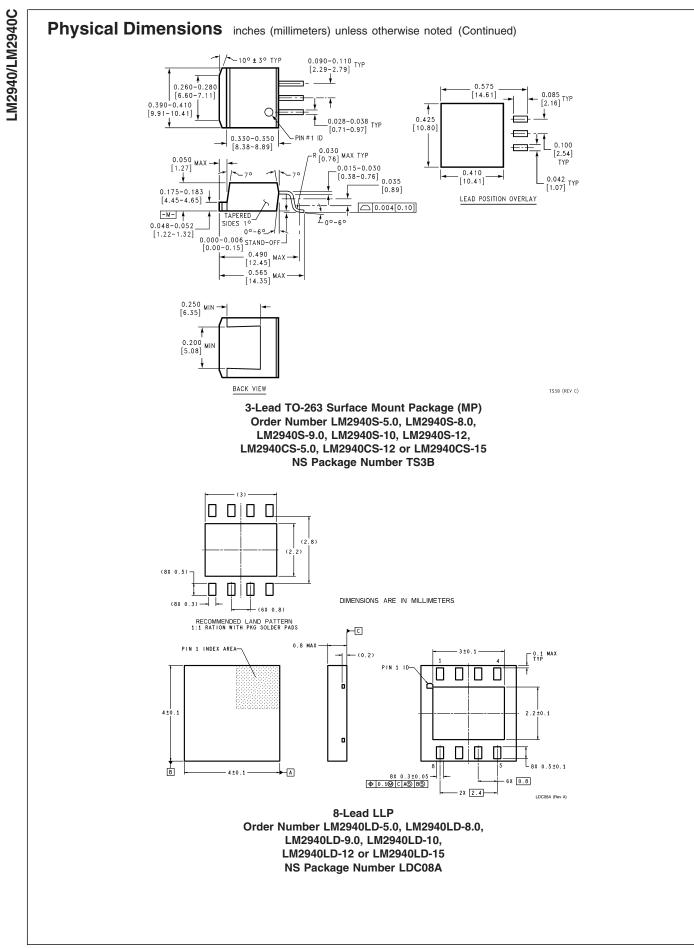


FIGURE 6. Maximum Power Dissipation vs. $\mathrm{T}_{\mathrm{AMB}}$ for the SOT-223 Package

Physical Dimensions inches (millimeters) unless otherwise noted







Notes

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